

Technical Data Sheet

Features

- High sensitivity.
- Low capacitance.
- Short switching time
- Wide temperature range
- Small package.



Descriptions

The SE4540PDD is high sensitivity, fast switching times, low capacitance, compact size, and lack of measurable degradation make it suitable for diverse applications, such as TV and appliance remote control, I sound transmission, video recorders, and measurement and control.

Applications

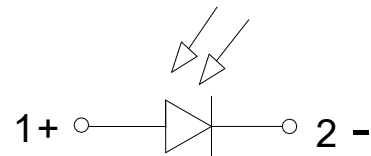
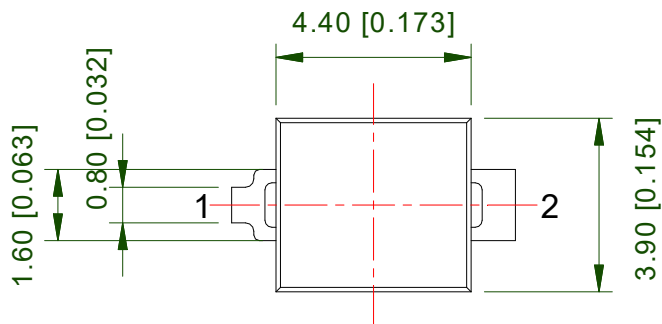
- Access Control & Security
- Factory Automation
- Appliances & Tools
- Home & Building Automation
- Blood oxygen system

Device Selection Guide

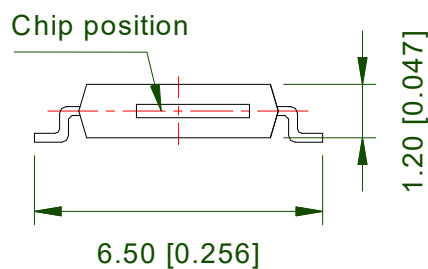
Part No.	Emitting Color	Lens Color
SE4540PDD-TR2	Photodiode	Black

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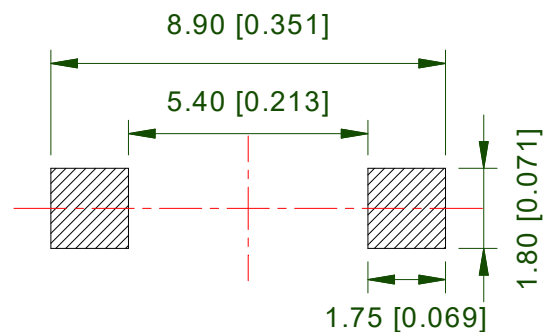
Package Dimension



Polarity



Recommended Soldering Pad Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.

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Absolute Maximum Ratings at Ta=25°C

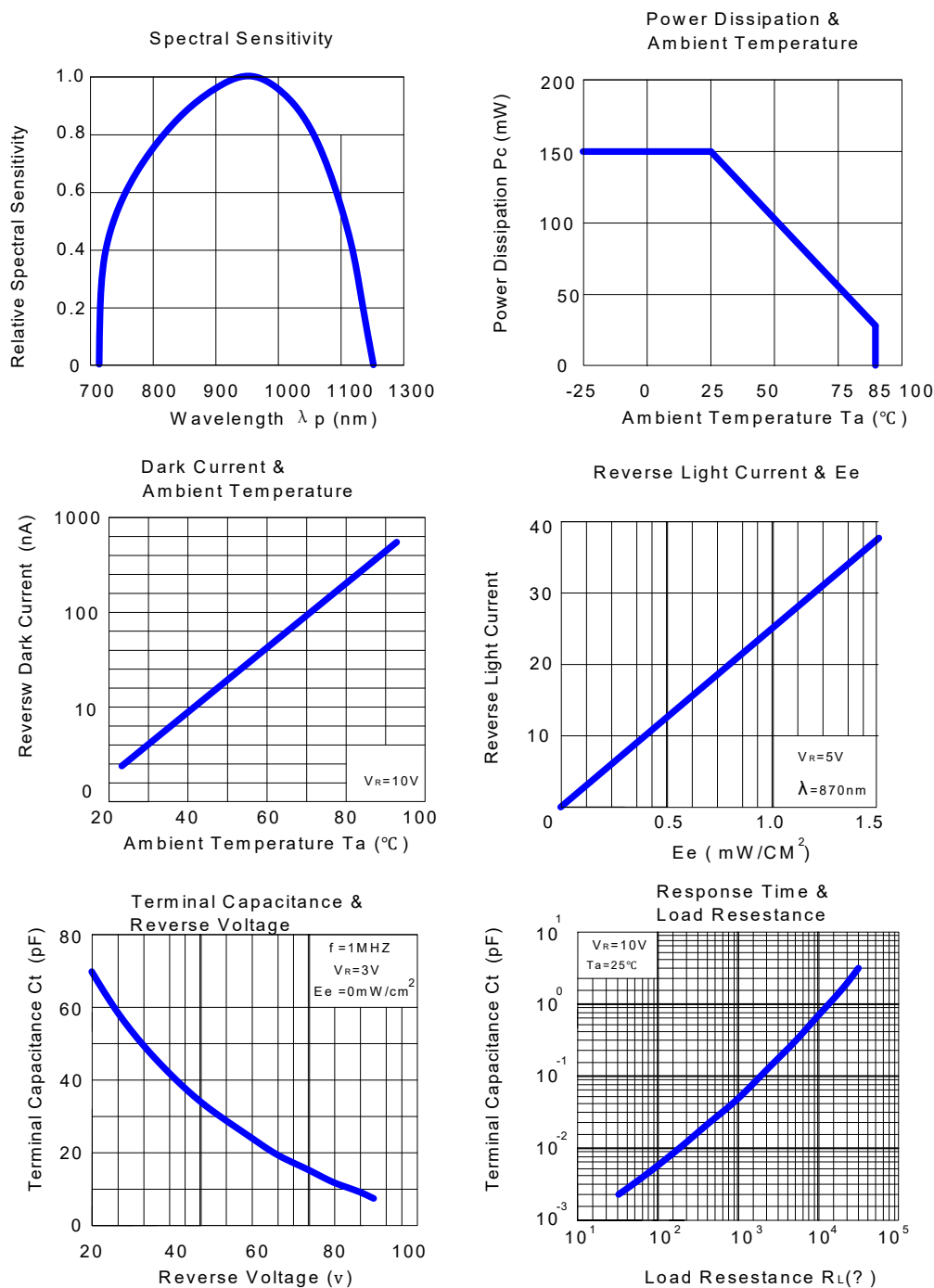
Parameters	Symbol	Max.	Unit
Power Dissipation	PD	150	mW
Reverse Voltage	VR	32	V
Operating Temperature Range	Topr	-40°C to +85°C	
Storage Temperature Range	Tstg	-40°C to +85°C	
Lead Soldering Temperature	Tsld	260°C for 5 Seconds	

Electrical Optical Characteristics at Ta=25°C

Parameters	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Reverse Breakdown voltage	Bvr	32	170	---	V	Ir=100uA, Ee=0mW/cm ²
Dark Current	Id	---	5	30	nA	Ee=0mW/cm ² VR=10V
Total Capacitance	Ct	---	25	---	pF	Ee=0mW/cm ² , VR=3V, f=1MHZ
Rise Time (10% to 90%)	Tr	---	50	---	nS	VR=10V, RL=1kΩ,
Fall Time (90% to 10%)	Tf	---	50	---		
Wavelength of Peak Sensitivity	λp	---	940	---	nm	
Rang of Spectral Bandwidth	λ0.5	730	---	1100	nm	
Open-circuit Voltage	Vo	---	0.35	---	V	Ee=5mW/cm ² λp=940nm
Short-Circuit Current	Isc	---	35	---	uA	Ee=1mW/cm ² λp=940nm
Viewing Angle	2θ1/2	---	120	---	Deg	
Reverse Light Current	IL	17	25	---	uA	Ee=1mW/cm ² λp=870nm Vr=5v
		25	37	---	UA	Ee=1mW/cm ² λp=940nm Vr=5v

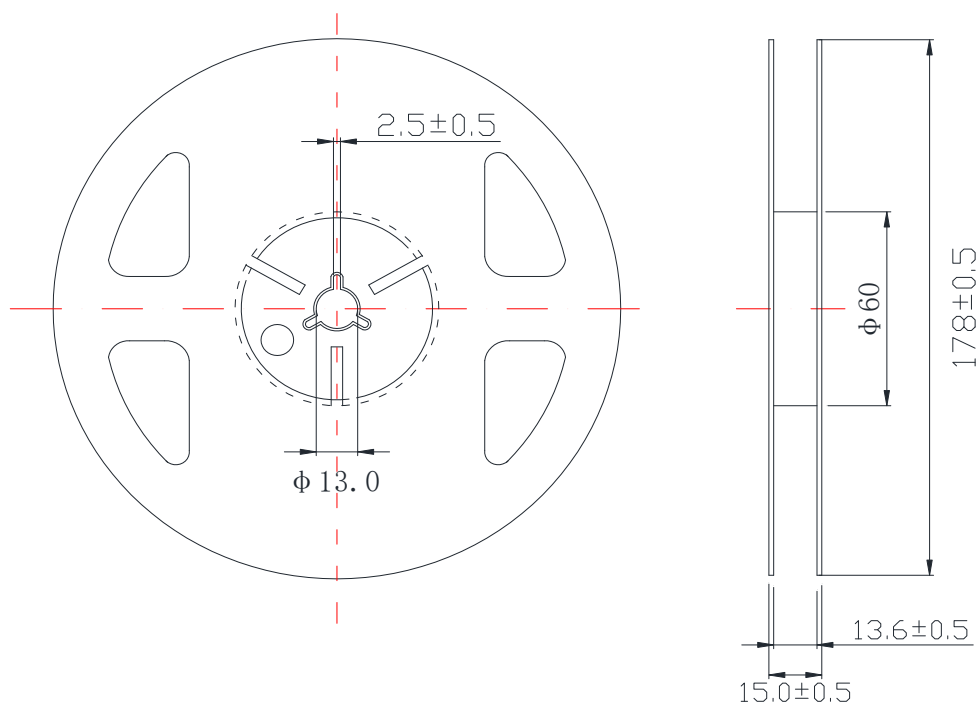
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Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)



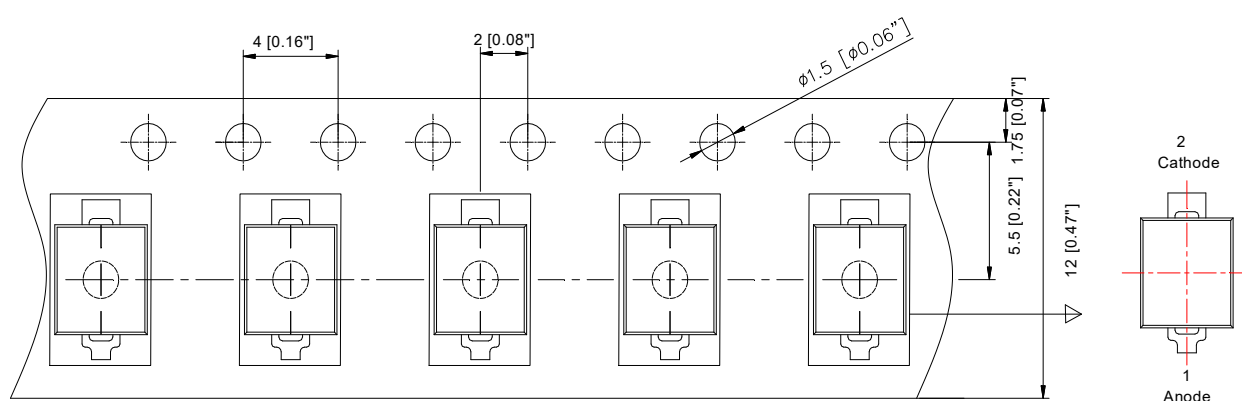
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Reel Dimensions



Carrier Tape Dimensions

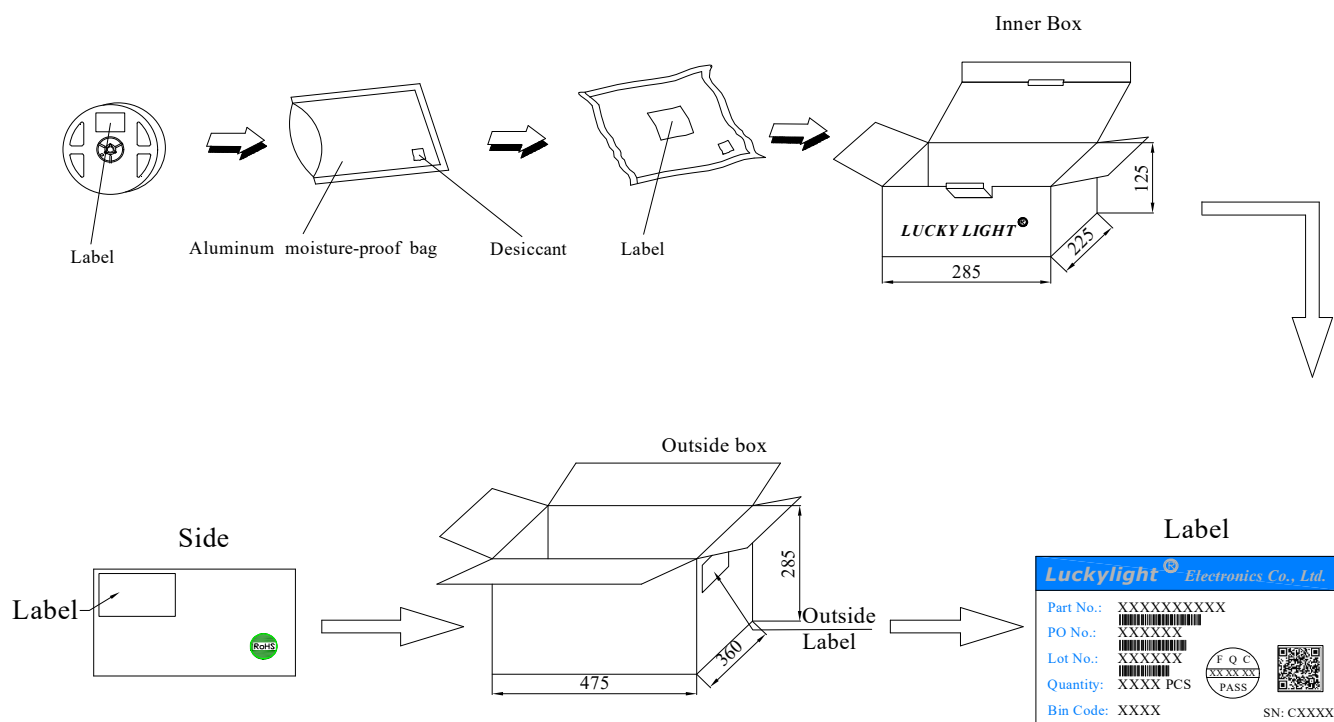
Loaded quantity 1000 pcs per reel.



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Packing & Label Specifications

Moisture Resistant Packaging

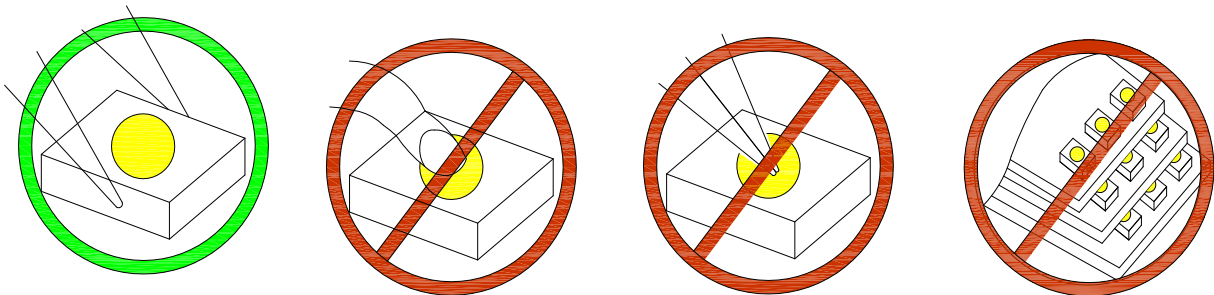


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CAUTIONS

1. Handling Precautions:

- 1.1 Handle the component along the side surfaces by using forceps or appropriate tools.
- 1.2 Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
- 1.3 Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



1.4 Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

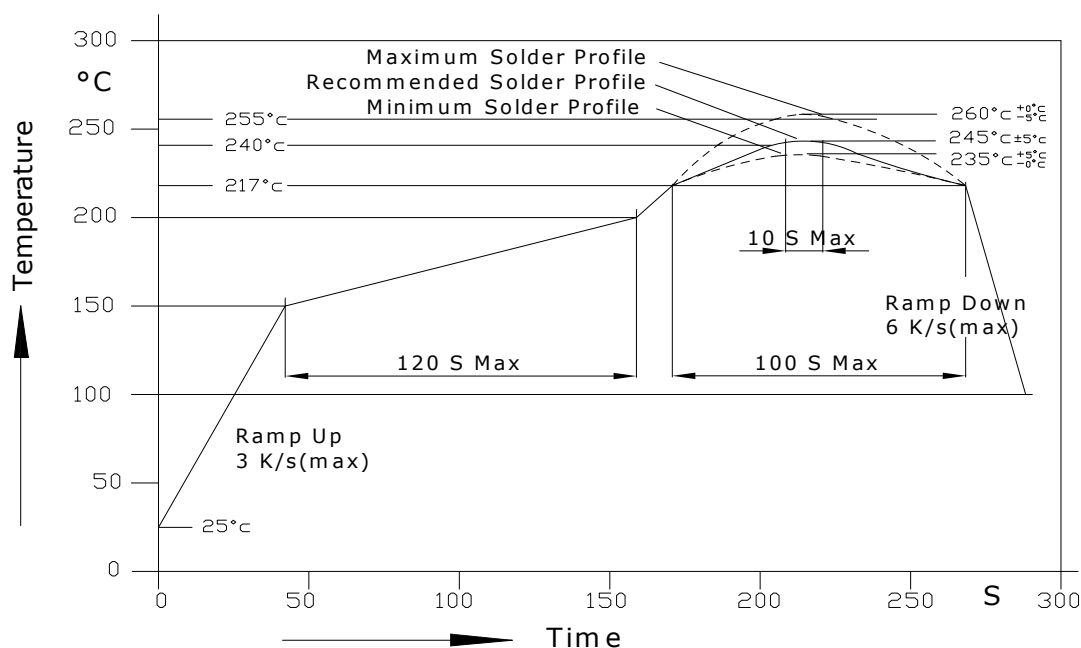
2. Storage:

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5 The LEDs should be used within 24 hours after opening the package.
- 2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 65±5°C for 24 hours.

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3. Soldering Condition:

3.1 Pb-free solder temperature profile.



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

3.5 Recommended soldering conditions:

Reflow soldering		Soldering iron	
Pre-heat	150~200°C	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	260°C Max.		(one time only)
Soldering time	10 sec. Max. (Max. two times)		

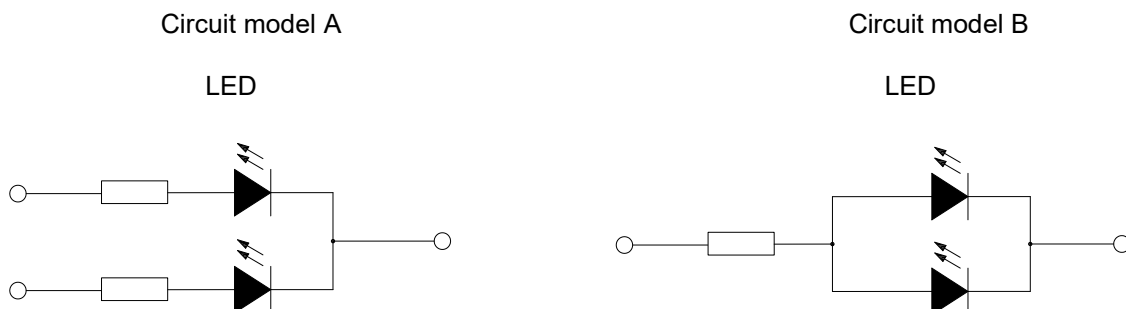
3.6 Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

4. Drive Method:

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4.1 An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



(A) Recommended circuit.

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

5. ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents. To verify for ESD damage, check for "lightup" and V_f of the suspect LEDs at low currents. The V_f of "good" LEDs should be $>2.0V@0.1mA$ for InGaN product and $>1.4V@0.1mA$ for AlInGaP product.

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Revision History

Version	Date	Revision History	Page
Rev-1	12-Feb-2015	Initial release	—
Rev-2	09-Aug-2024	Revise Package Drawings and Characteristic Curves.	P2、 P4